

IS918M / IS818 Flash Support List (May 14, 2019)

| Flash Vendor | Flash Part Number | Die Name | Flash ID | Process | Cell Level-1 | Cell Level-2 | Tiers | Density | Die Stack | Remark |
|--------------|-------------------|----------|--|---------|--------------|--------------|-------|---------|-----------|---------|
| SanDisk | SDTNBIAMA-016G | FRN2 | 45 3A 98 B3 76 72 | 3D | TLC | Gen3 | 64 | 128Gb | x1, x2 | |
| | SDYNBIAMA-032G | FRN1 | 45 3C 98 B3 76 72 | 3D | TLC | Gen3 | 64 | 256Gb | x1, x2 | |
| | SDTNBIAMA-064G | FRN4 | 45 3E 98 B3 76 72 | 3D | TLC | Gen3 | 64 | 512Gb | x1, x2 | |
| | SDTNCIAMA-032G | FST0 | 45 3C 98 B3 76 6B | 3D | TLC | Gen4 | 96 | 256Gb | x1, x2 | |
| Toshiba | TC58TFG7T23TA0D | FRN2 | 98 3A 98 B3 76 72 | 3D | TLC | BiCS3 | 64 | 128Gb | x1, x2 | |
| | TC58TFG8T23TA0D | FRN1 | 98 3C 98 B3 76 72 | 3D | TLC | BiCS3 | 64 | 256Gb | x1, x2 | |
| | TC58TFG9T23TA0D | FRN4 | 98 3E 98 B3 76 72 | 3D | TLC | BiCS3 | 64 | 512Gb | x1, x2 | |
| | TC58LJG8T24TA0D | FRV8 | 98 3E 98 B3 76 E3 | 3D | TLC | BiCS4 | 96 | 256Gb | x1, x2 | |
| | TC58LJG9T24TA0D | | 98 3C 98 B3 76 E3 | 3D | TLC | BiCS4 | 96 | 512Gb | x1 | |
| Intel | PF29F32B2ALCMG2 | L06B | 89 A4 64 32 AA 01 | 3D | MLC | | 32 | 256Gb | x1, x2 | |
| | PF29F32B2ALCTH2 | B16A | 89 A4 08 32 A1 00 | 3D | TLC | | 64 | 256Gb | x1, x2 | |
| | PF29F64B2ALCTH1 | B17A | 89 C4 08 32 A6 00 | 3D | TLC | | 64 | 512Gb | x1, x2 | |
| | PF29F01T2ALCQH1 | N18A | 89 D4 0C 32 AA 00 | 3D | QLC | | 64 | 1024Gb | x1 | |
| | PF29F64B2ALCTJ1 | B27A | 89 C4 08/18 32 A2 00 | 3D | TLC | | 96 | 512Gb | x1 | |
| Micron | MT29F256G08CBCBB | L06B | 2C A4 64 32 AA 04 | 3D | MLC | | 32 | 256Gb | x1, x2 | |
| | MT29F128G08EBCDB | B05A | 2C 84 58/D8 32 A1 00/04 | 3D | TLC | | 32 | 128Gb | x1 | |
| | MT29F256G08EBHAF | B16A | 2C A4 08 32 A1 00 2C A4 88 32 A1 00 | 3D | TLC | | 64 | 256Gb | x1, x2 | |
| | MT29F512G08EBHAF | B17A | 2C C4 08 32 A6 01 | 3D | TLC | | 64 | 512Gb | x1, x2 | |
| | MT29F1T08GBCAGJ | N18A | 2C D4 0C 32 AA 00 | 3D | QLC | | 64 | 1024Gb | x1 | |
| | MT29F512G08EBHBF | B27A | 2C C4 08/18 32 A2 00 | 3D | TLC | | 96 | 512Gb | x1 | |
| SpecTek | FNNL06B256G1KDBAB | L06B | B5 A4 64 32 AA 04 | 3D | MLC | | 32 | 256Gb | x1, x2 | |
| | FNNB05A128G1KDBAB | B05A | B5 84 58/D8 32 A1 00 | 3D | TLC | | 32 | 128Gb | x1 | |
| | FNNB16A256G1DHBAF | B16A | B5 A4 08 32 A1 00 | 3D | TLC | | 64 | 256Gb | x1, x2 | |
| Hynix | H27QEG8M3M | V3 | AD 5C 28 BA 00 80 | 3D | TLC | | 48 | 256Gb | x1, x2 | |
| | H27QEG8M2A | V4 | AD 5C 28 2A 01 90 | 3D | TLC | | 72 | 256Gb | x1, x2 | |
| | H25QFT8A1A | V4 | AD 5E 28 22 10 90 | 3D | TLC | | 72 | 512Gb | x1, x2 | |
| | H25BFT8A1M | V5 | AD 5E 28 33 00 A0 | 3D | TLC | | 96 | 512Gb | x1 | 2019-Q2 |
| Samsung | K9AFGD8H0A | V4 | EC 1C 98 3F 84 CB | 3D | TLC | | 64 | 256Gb | x1 | 2019-Q2 |